



position of active transistor, respective  $r$ -th active section. The oscillation frequency can be obtained from equation

$$2 \cdot k \cdot \mathbf{p} = (2 \cdot r - 1) \cdot \Phi(f_{osc}) + \mathbf{p} \quad (1)$$

where  $\Phi$  is the phase shift over one artificial transmission line section,  $r$  stands for active section position and  $\mathbf{p}$  stands for a phase shift caused by an active FET in common source arrangement.

The oscillator is capable of oscillating between two discrete frequencies belonging to single transistors if two FETs are biased in active region at the same time. The oscillation frequency is given by total phase path of oscillation loopback. The phase path is calculated as a vector sum of two phase paths per two active FETs with different position and transconductivity. In such a manner the oscillator can be tuned for all frequencies within its tuning range, with one exception. The exception comes into effect if the phase difference between two active paths approaches  $\pi$ . A result of a sum of two anti-phase vectors is nearly zero resulting in oscillation loopback gain less than unity. This effect is encountered between first and second FETs at  $0.7 f_c$  (critical frequency of artificial transmission line). The problem can be solved by an additional FET connected between the first and the second section, as depicted at Fig. 1.

The oscillation frequency can be predicted using CAD techniques as a function of active FETs positions and differential transconductivities. This tuning function depends on the type of artificial transmission line section used. The tuning function prediction provides for  $g_m$  (differential transconductivity) required from each pair of FETs. The tuning function is called here "linear" function because it is derived from linear (small-signal) parameters of FET (differential transconductivity).

### III. EXPERIMENTAL REALISATION OF THE DISTRIBUTED OSCILLATOR AT 4 GHz.

As we learned from [2] and subsequent analyses, there are several important goals that should be achieved in order to design a good distributed oscillator.

- Good match, both in drain and gate lines. The match should be better than -20 dB over the tuning range. (Otherwise parasitic oscillations occur.)
- The artificial lines should form a lowpass filter. (Otherwise the spectral purity of the output signal suffers.)
- The crucial point is in introducing the transistor between the first and second stage.
- The artificial transmission line should be composed of M-derived sections.
- Periodically loaded transmission line concept [3] was found suitable to achieve these goals.

- The design should take into account non-linearities in the circuit in order to develop a suitable tuning function.

In order to test the idea of a distributed oscillator at microwave frequencies, we have chosen a frequency of 4 GHz approx. The choice has been predetermined by the fact that this frequency is high enough for all circuit parameters to be in effect, yet low enough to allow for use of packaged devices. The design has been enabled by experience obtained in our last distributed oscillator design at 100 MHz [2] and facilitated by a number of computer simulations, both linear and non-linear.

At the design frequency lumped elements (inductors and FETs) exhibit considerable parasitic elements values, some of those bias dependent. These parasitic elements must be accounted for during design. Periodically loaded transmission lines and M-derived sections were used. As to circuit layout, the cornerstone is found in connecting the FET between the first and second stage. Proper line lengths should be maintained, while the demands imposed by first and second stages are somewhat contradictory.

### IV. REALISATION OF THE DISTRIBUTED OSCILLATOR.

The oscillator consists of 3 sections with 4 FETs. The FET is PHEMT ATF35376 that has good gain and minimal values of parasitic elements. The oscillation frequency is controlled by change of gate bias voltages. The critical frequency of the oscillator is 3.8 GHz realised as M-derived sections of periodically loaded transmission line with added capacitors. The oscillator is matched by half M-derived section realised with distributed elements. The gate bias filters are realised with high impedance on the output of the filter and composed of a resistor and shunt capacitor. The drain bias filter is realised with the same goals as LC T-network and each FET drain is biased through the artificial transmission line. This experimental sample of the oscillator has made use of planar technology with MIS capacitors where needed. The oscillator is realised on CU-CLAD substrate with  $\epsilon_r = 2.33$ . Low dielectric constant allows for a relatively large circuit. The topology and

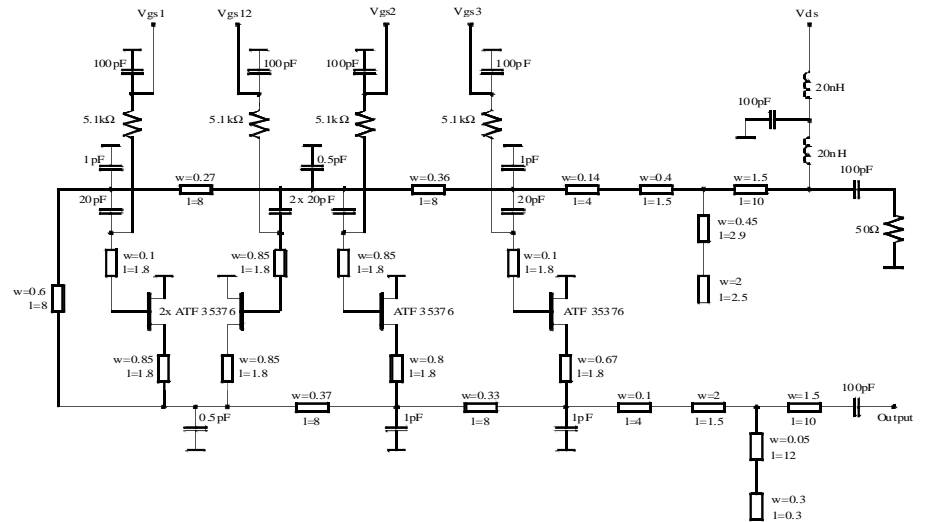


Fig. 2. Simplified schematic diagram of the oscillator.

layout could be seen at Fig. 3.

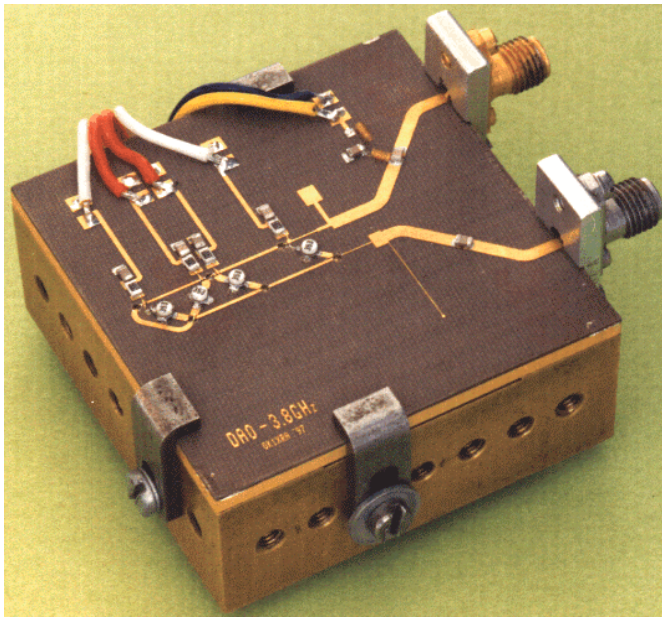


Fig. 3. Photo of real sample of the oscillator at 4 GHz. Dimensions of the board 50x50 millimeters.

#### V. RESULTS

The oscillator is working well, meeting design goals. The tuning range is 1 to 3.5 GHz with output power 3 to 11 dBm. The oscillator has very good spectral purity as a narrow spectral line and very good depression of second and third harmonic frequency have been achieved (see Fig. 3). The depression of second harmonic frequency ranges from -44 dB to -18 dB. The depression of about -35 dB is achieved at frequencies over  $f_c/2$  (second harmonic) or  $f_c/3$  (third harmonic), where second (third) harmonic frequency is not propagated.  $f_c$  stands for the critical frequency of artificial transmission line. The third harmonic frequency is depressed from -55 dB to -17 dB. A sample of output spectrum can be seen on Fig. 4.

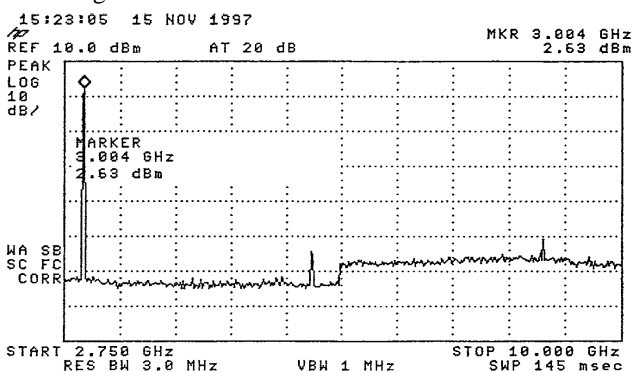


Fig. 4. An example of measured output spectrum of the oscillator depicted at Fig. 3. Gate bias voltages set for oscillation at 3 GHz.

#### VI. CONCLUSION

The idea of a distributed oscillator has been found viable in microwave region. The oscillator is instantly tuneable. The output signal harmonic purity is at least well comparable to other tuneable oscillator arrangements in use. The oscillator is suitable for MMIC technology.

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#### REFERENCES

- [1] Škvor, Z. - Saunders, S. - Aitchison, C. S.: Novel decade electronically tuneable microwave oscillator based on the distributed amplifier. In: ELECTRONIC LETTERS 13th August 1992 Vol. 28 No. 17 pp 1647 - 1648
- [2] Divina, L. - Škvor, Z.: Experimental verification of adistributed amplifier oscillator. In: 25th EuMC 1995 Conference Proceedings. Kent: Nexus Media Limited. 1995. p. 1163 - 1167.
- [3] Wong, T. T. Y.: Fundamentals of distributed amplification. Artech House, London 1993
- [4] Divina, L.: On a distributed amplifier oscillator. In: COMITE 1997. Vol. 1. Czechoslovakia Section IEEE, Pardubice 1997. pp. 33 - 36.
- [5] Hewlett-Packard: SeriesIV 6.5 PC.
- [6] Pengelly, R. S.: Microwave Field-Effect Transistors - Theory, Design and Application (second edition). Research studies press, London 1986.